



SEMIPACK® 1

Rectifier Diode Modules

SKKD 100

Features

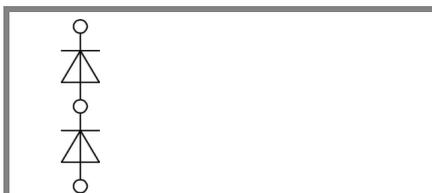
- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- SKKD half bridge connection center-tap connections
- UL recognized, file no. E 63 532

Typical Applications*

- Non-controllable rectifiers for AC/AC converters
- Line rectifiers for transistorized AC motor controllers
- Field supply for DC motors

V_{RSM} V	V_{RRM} V	$I_{FRMS} = 175$ A (maximum value for continuous operation) $I_{FAV} = 100$ A (sin. 180; $T_c = 85$ °C)		
1300	1200	SKKD 100/12		
1700	1600	SKKD 100/16		
1900	1800	SKKD 100/18		

Symbol	Conditions	Values	Units
I_{FAV}	sin. 180; $T_c = 85$ (100) °C	100 (67)	A
I_D	P3/180; $T_a = 45$ °C; B2 / B6	73 / 91	A
	P3/180F; $T_a = 35$ °C; B2 / B6	150 / 190	A
I_{FSM}	$T_{vj} = 25$ °C; 10 ms	2500	A
	$T_{vj} = 125$ °C; 10 ms	2000	A
i^2t	$T_{vj} = 25$ °C; 8,3 ... 10 ms	31250	A ² s
	$T_{vj} = 125$ °C; 8,3 ... 10 ms	20000	A ² s
V_F	$T_{vj} = 25$ °C; $I_F = 300$ A	max. 1,35	V
$V_{(TO)}$	$T_{vj} = 125$ °C	max. 0,85	V
r_T	$T_{vj} = 125$ °C	max. 1,3	mΩ
I_{RD}	$T_{vj} = 125$ °C; $V_{RD} = V_{RRM}$	max. 5	mA
$R_{th(j-c)}$	per diode / per module	0,35 / 0,175	K/W
$R_{th(c-s)}$	per diode / per module	0,2 / 0,1	K/W
T_{vj}		- 40 ... + 125	°C
T_{stg}		- 40 ... + 125	°C
V_{isol}	a. c. 50 Hz; r.m.s.; 1 s / 1 min.	3600 / 3000	V~
M_s	to heatsink	5 ± 15 %	Nm
M_t	to terminals	3 ± 15 %	Nm
a		5 * 9,81	m/s ²
m	approx.	95	g
Case	SKKD	A 10	



SKKD

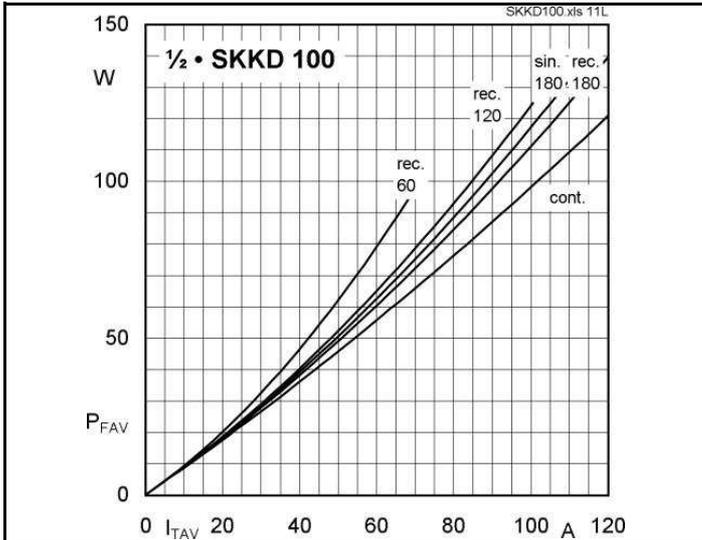


Fig. 11L Power dissipation per diode vs. forward current

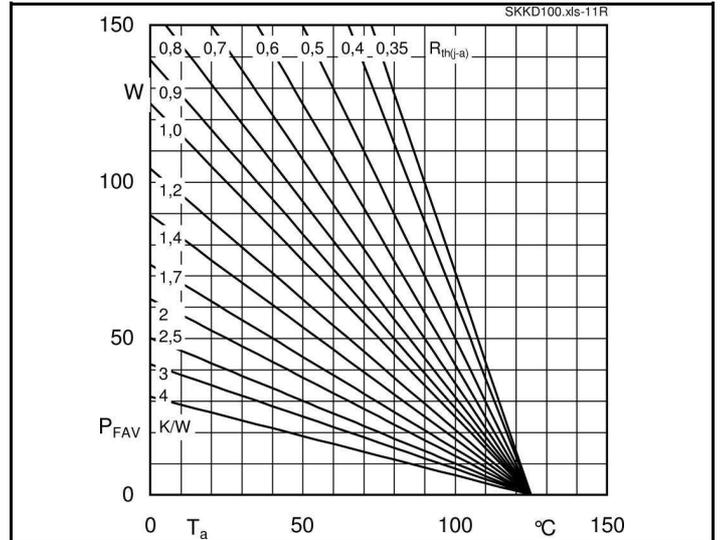


Fig. 11R Power dissipation per diode vs. ambient temperature

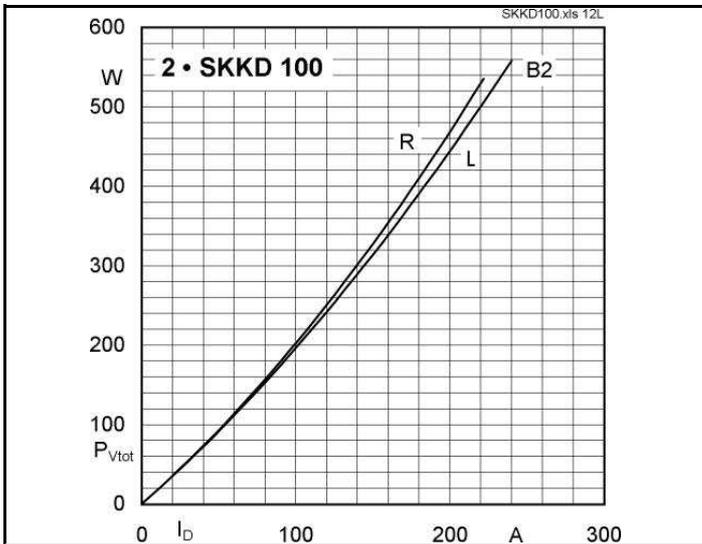


Fig. 12L Power dissipation of two modules vs. direct current

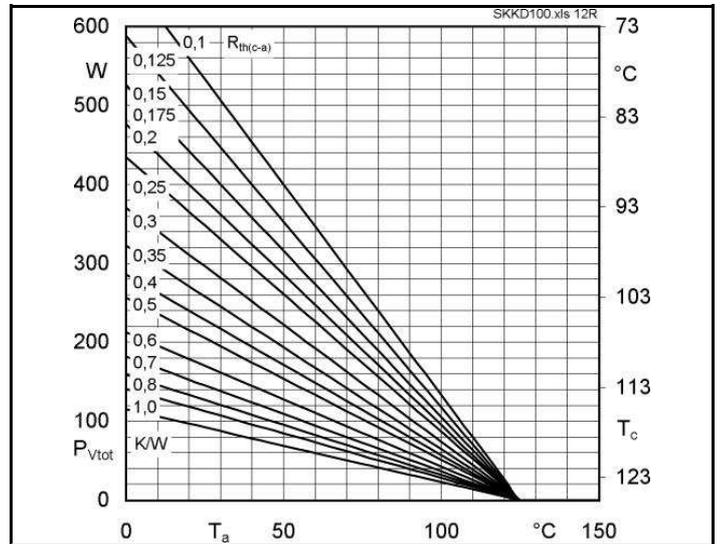


Fig. 12R Power dissipation of two modules vs case temperature

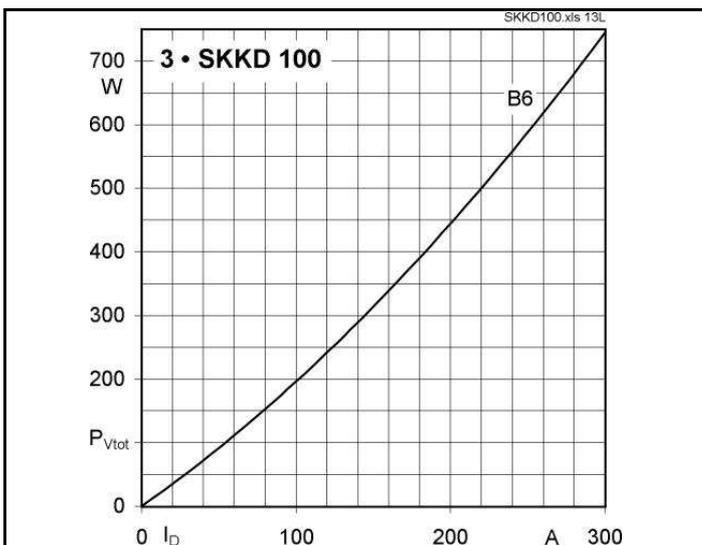


Fig. 13L Power dissipation of three modules vs. direct current

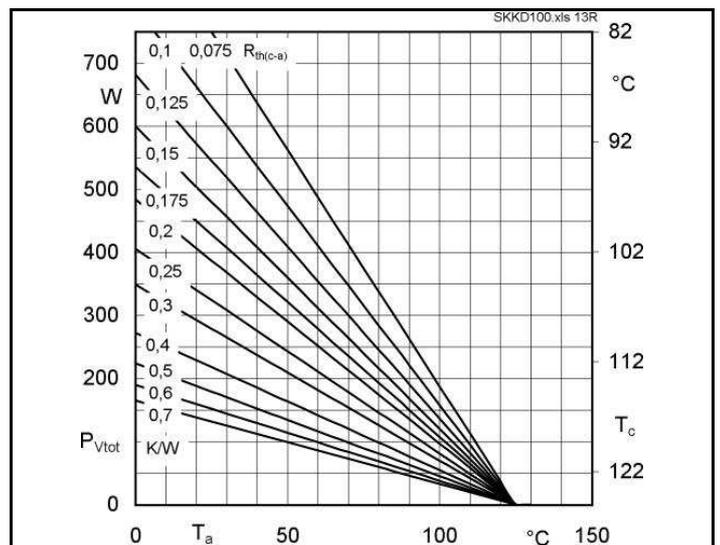
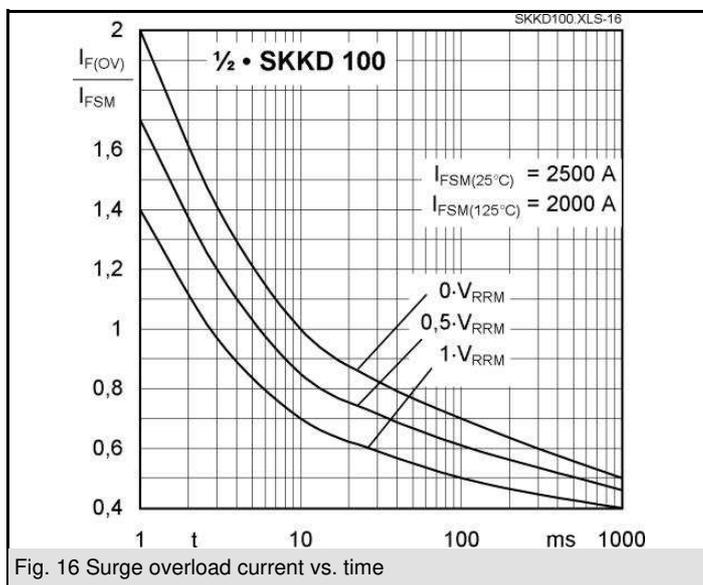
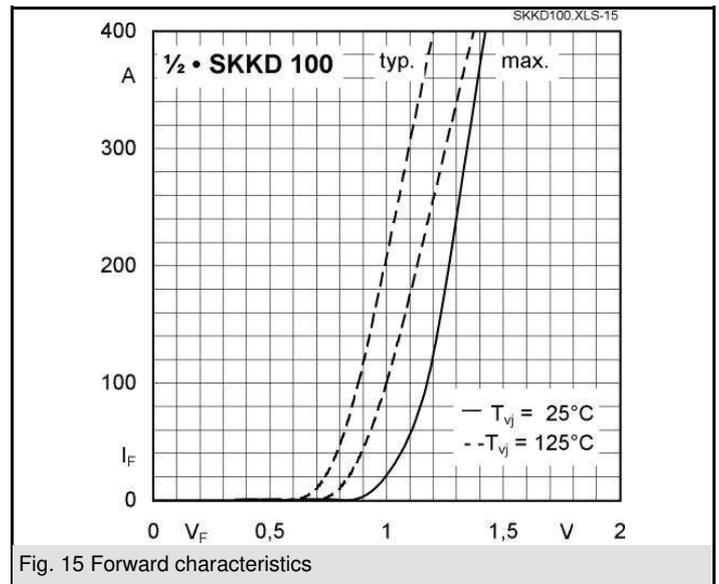
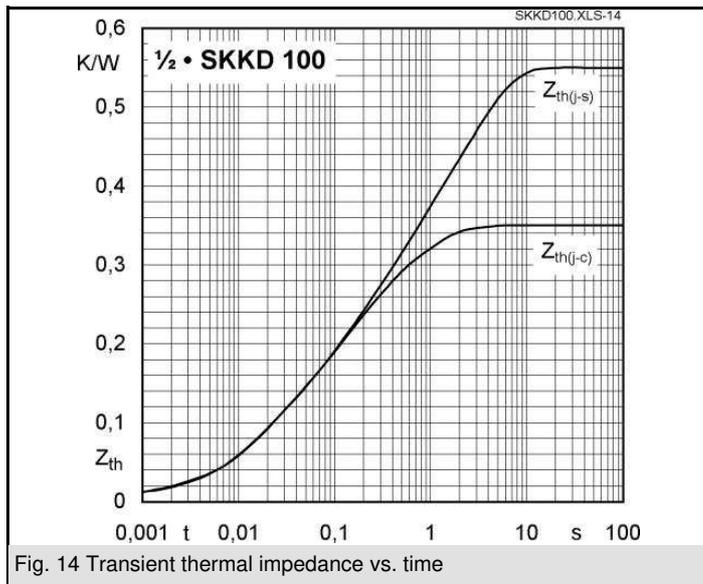
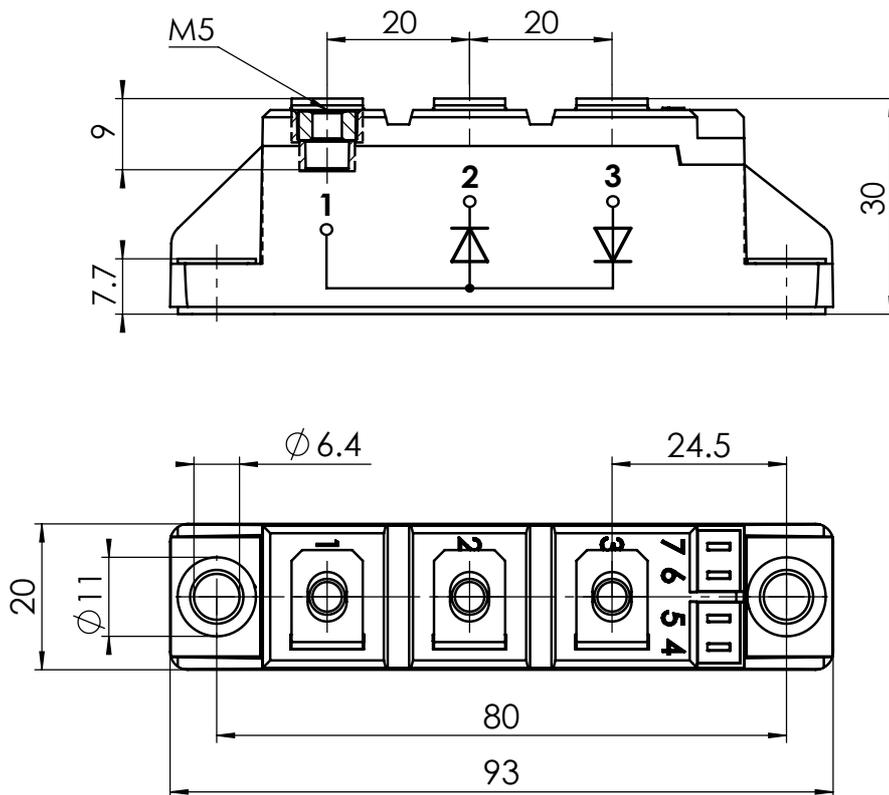


Fig. 13R Power dissipation of three modules vs. case temperature



Dimensions in mm

General tolerance ± 0.5 mm



Case A 10 (SKKD)

IMPORTANT INFORMATION AND WARNINGS

This is an electrostatic discharge sensitive device (ESDS) according to international standard IEC 61340.

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